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Data sheet

SAW duplexer Automotive telematics LTE band 21

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2.0

Version:

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1 Application

- LTE band 21 uplink: 1455.4 MHz (pass band 15 MHz)
- LTE band 21 downlink: 1503.4 MHz (pass band 15 MHz)
- Low insertion attenuation
- High isolation between Tx and Rx

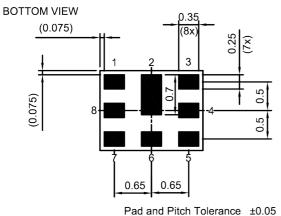
2 Features

- Package size 1.8±0.1 mm × 1.4±0.1 mm
- Package height 0.45 mm (max.)
- Approximate weight 4 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Overmold demonstrated with RF360 specific mold process
- Moisture Sensitivity Level 2a (MSL2a)
- AEC-Q200 qualified component family (Grade 3: -40 °C to +85 °C)



Figure 1: Picture of component with example of product marking.

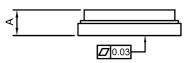
3 Package

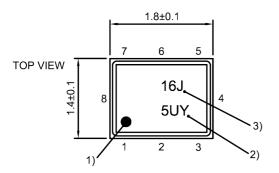


4 **Pin configuration**

- 1 RX
- **3** ТΧ
- ANT 6
- **■** 2, 4, 5, 7, Ground 8

SIDE VIEW



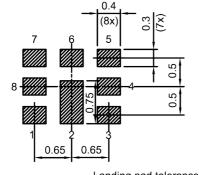


1) Marking for pad number 1

2) Example of encoded lot number

3) Example of encoded filter type number

Land pattern THRU VIEW



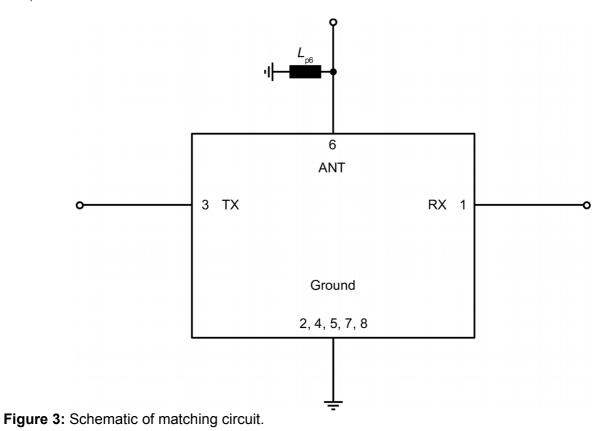
Landing pad tolerance -0.02 Figure 2: Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 21).

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5 Matching circuit

■ *L*_{p6} = 11 nH



6 Characteristics

6.1 TX – ANT

Temperature range for specification	$T_{_{\rm SPEC}}$	= −30 °C +85 °C
TX terminating impedance	Z _{TX}	= 50 Ω
ANT terminating impedance	Z	= 50 Ω // 11 nH ¹⁾
RX terminating impedance	Z _{RX}	= 50 Ω

Characteristics TX – ANT				min. for $T_{_{\rm SPEC}}$	typ. @ +25 °C	max. for T _{SPEC}	
Center frequency			f _c	—	1455.4	_	MHz
Maximum insertion attenuation			$\alpha_{_{max}}$				
	1447.9 1462.9	MHz		_	1.0	1.5	dB
Amplitude ripple (p-p)			Δα				
	1447.9 1462.9	MHz		—	0.5	1.0	dB
Maximum VSWR			VSWR _{max}				
@ TX port	1447.9 1462.9	MHz			1.6	2.0	
@ ANT port	1447.9 1462.9	MHz		—	1.6	2.0	
Minimum attenuation			$\alpha_{_{min}}$				
	100 400	MHz		42	46		dB
	400 1400	MHz		30	34	—	dB
	1400 1409	MHz		25	33	—	dB
	1475.9 1495.9	MHz		5 ²⁾	6.5	—	dB
	1495.9 1510.9	MHz		49	53	—	dB
	1510.9 2400	MHz		30	36	—	dB
	2400 3000	MHz		25	41	—	dB
	3300 4200	MHz		28	33	—	dB
	4343 5950	MHz		20	25	—	dB
	4400 4990	MHz		25	29	_	dB

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Valid for temperature T = +25 °C...+85 °C.

6.2 ANT – RX

Temperature range for specification	$T_{_{\rm SPEC}}$	= −30 °C +85 °C
TX terminating impedance	Z _{TX}	= 50 Ω
ANT terminating impedance	Z	= 50 Ω // 11 nH ¹⁾
RX terminating impedance	Z _{RX}	= 50 Ω

Characteristics ANT – RX				min. for $T_{_{\rm SPEC}}$	typ. @ +25 °C	max. for $T_{\rm SPEC}$	
Center frequency			f _c	—	1503.4	_	MHz
Maximum insertion attenuation			$\alpha_{_{max}}$				
	1495.9 1510.9	MHz		_	1.6	2.0	dB
Amplitude ripple (p-p)			Δα				
	1495.9 1510.9	MHz		—	0.8	1.0	dB
Maximum VSWR			VSWR _{max}				
@ ANT port	1495.9 1510.9	MHz		—	1.8	2.0	
@ RX port	1495.9 1510.9	MHz		—	1.6	2.0	
Minimum attenuation			$\alpha_{_{min}}$				
	100 830	MHz		50	58	—	dB
	830 845	MHz		50	58	—	dB
	845 1409	MHz		38	46	—	dB
	1409 1447.9	MHz		35	44	—	dB
	1447.9 1462.9	MHz		49	53	—	dB
	1472 1480	MHz		4	11	_	dB
	1596 2400	MHz		40	42	—	dB
	2400 5000	MHz		40	48	_	dB
	5000 6000	MHz		30	38		dB

¹⁾ See Sec. Matching circuit (p. 6).

6.3 TX – RX

Temperature range for specification	$T_{_{\rm SPEC}}$	= −30 °C +85 °C
TX terminating impedance	Z _{TX}	= 50 Ω
ANT terminating impedance		= 50 Ω // 11 nH¹)
RX terminating impedance	Z _{RX}	= 50 Ω

Characteristics TX – RX				min. for $T_{_{ m SPEC}}$	typ. @ +25 °C	max. for T _{SPEC}	
Minimum isolation			$\boldsymbol{\alpha}_{min}$				
	1447.9 1462.9	MHz		52	55	_	dB
	1495.9 1510.9	MHz		51	55	_	dB
	1574 1577	MHz		30	62	_	dB
	2855.8 2905.8	MHz		30	51	_	dB
	4283.7 4358.7	MHz		25	47	_	dB

¹⁾ See Sec. Matching circuit (p. 6).

7 **Maximum ratings**

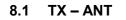
Operable temperature	T _{OP} = −40 °C +85 °C	
Storage temperature	<i>T</i> _{STG} ¹⁾ = −40 °C +85 °C	
DC voltage	$ V_{\rm DC} ^{2} = 0 V (max.)$	
Input power @ TX port: 1447.9 1462.9 MHz	P _{IN} = 29 dBm	Continuous wave for 5000 h @ 50 °C.

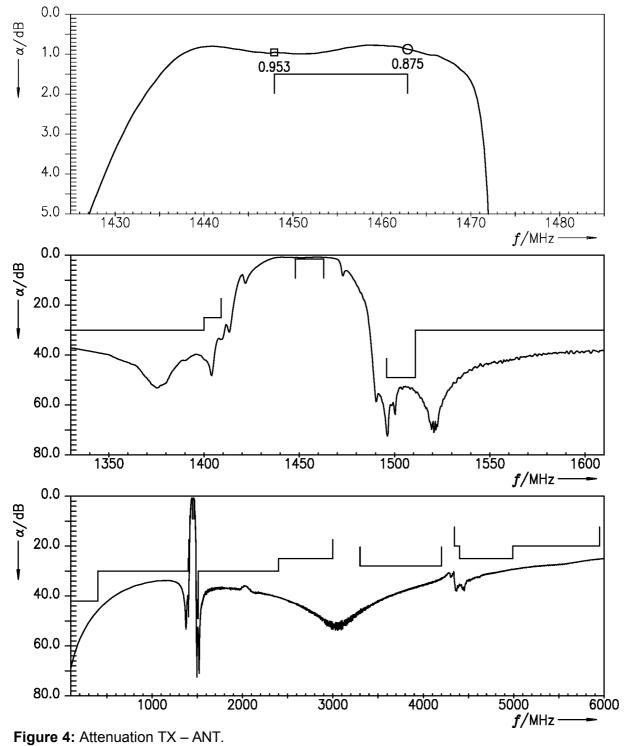
Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C. In case of applied DC voltage blocking capacitors are mandatory. 1)

2)



8 Transmission coefficients





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8.2 ANT – RX

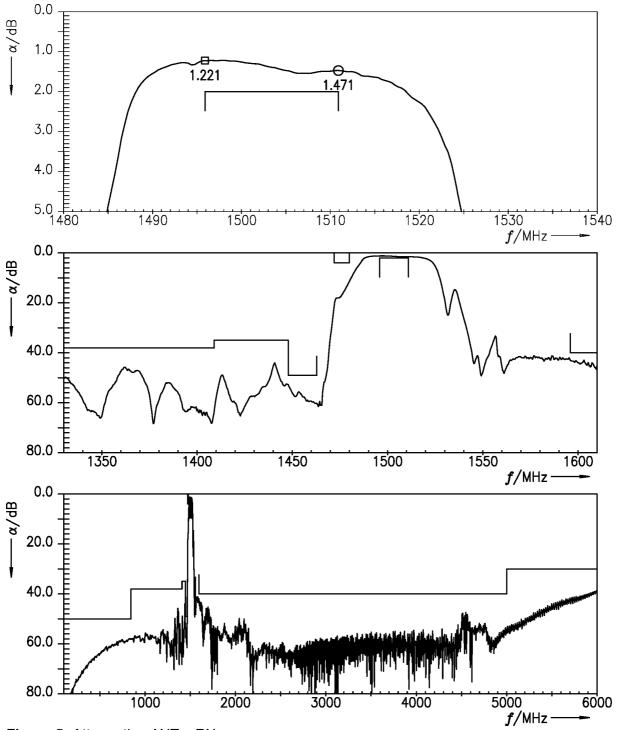
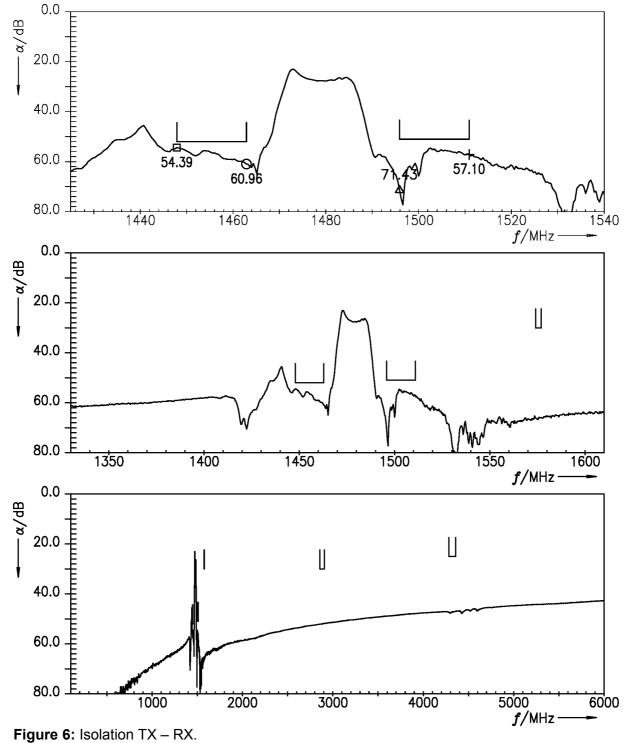


Figure 5: Attenuation ANT – RX.

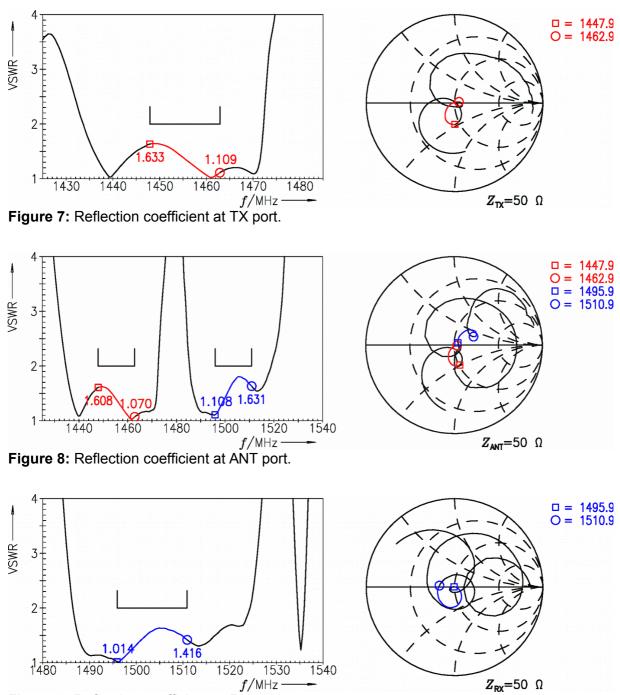
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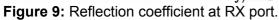
8.3 TX – RX





9 Reflection coefficients

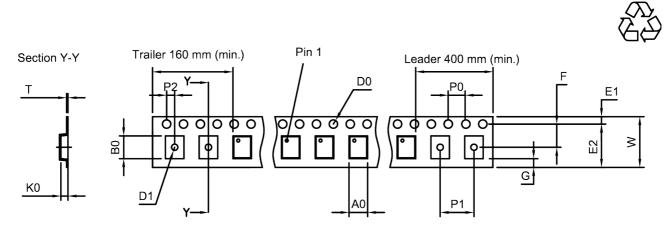






10 Packing material

10.1 Tape



User direction of unreeling

Figure 10: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

 A0
 1.6±0.05 mm

 B0
 2.0±0.05 mm

 D0
 1.5±0.1/-0 mm

 D1
 0.8±0.1/-0 mm

 E1
 1.75±0.1 mm

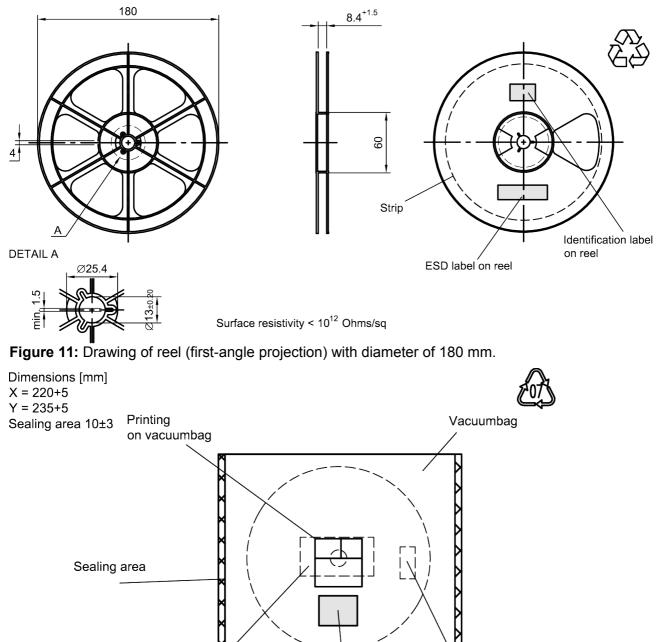
Table 1: Tape dimensions.

6.25 mm (min.)
3.5±0.05 mm
0.75 mm (min.)
0.64±0.05 mm
4.0±0.1 mm

P ₁	4.0±0.1 mm
P ₂	2.0±0.05 mm
Т	0.25±0.03 mm
W	8.0+0.3/-0.1 mm



10.2 Reel with diameter of 180 mm



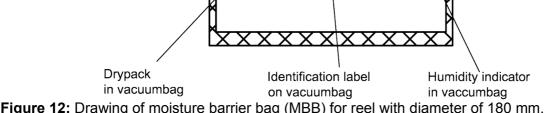
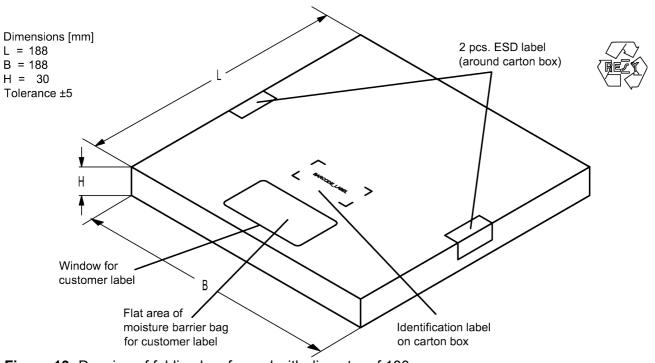
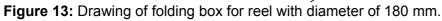


Figure 12: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

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11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number is encoded by a special	of the ordering code, BASE32 code into a 3 digit marking.	e.g., B3xxxxB <u>1234</u> xxxx,
	type number marking on device \Rightarrow $32^{1} + 18 (=J) \times 32^{0} =$	in decimal code. 1234 1234
The BASE32 code for pl	oduct type B4439 is 4AQ.	

■ Lot number:

The last 5 digits of the lot number, 12345, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device 5UY

5UY	=>	12345
5 x 47 ² + 27 (=U) x 47 ¹ + 31 (=Y) x 47 ⁰	=	12345

Adopted BASE32 code for type number			
Decimal	Base32	Decimal	Base32
value	code	value	code
0	0	16	G
1	1	17	Н
2	2	18	J
3	3	19	K
4	4	20	М
5	5	21	N
6	6	22	Р
7	7	23	Q
8	8	24	R
9	9	25	S
10	А	26	Т
11	В	27	V
12	С	28	W
13	D	29	Х
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal	Base47	Decimal	Base47
value	code	value	code
0	0	24	R
1	1	25	S
2	2	26	Т
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	В	35	f
12	С	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	Н	41	١
18	J	42	?
19	K	43	{
20	L	44	}
21	М	45	<
22	N	46	>
23	Р		

in decimal code.

Table 2: Lists for encoding and decoding of marking.

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12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s	
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s	
<i>T</i> > 220 °C	30 s to 70 s	
<i>T</i> > 230 °C	min. 10 s	
<i>T</i> > 245 °C	max. 20 s	
<i>T</i> ≥ 255 °C	_	
peak temperature T _{peak}	250 °C +0/-5 °C	
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s	
cooling rate	≤ 3 K/s	
soldering temperature T	measured at solder pads	

 Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

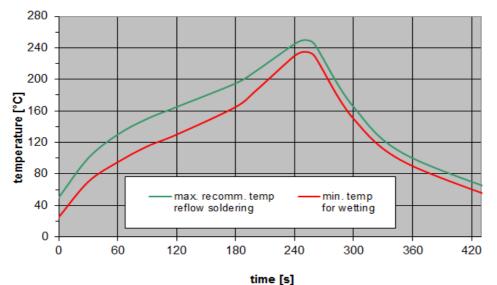


Figure 14: Recommended reflow profile for convection and infrared soldering – lead-free solder.

13 Annotations

13.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under https://rffe.qualcomm.com/.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.



15 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (<u>https://rffe.qualcomm.com</u>). Should you have any more detailed questions, please contact our sales offices.
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